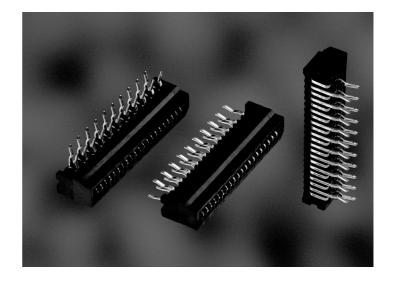
HLW series - LIF / Through hole



1.00 mm Spacing for FFC / FPC / CIC

Features

- Available in 4 to 32 positions
- Right angle and vertical type
- Kinked solder tails available



Benefits

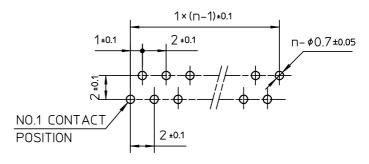
- The Gas-Tight, High pressure (GTH) contact system ensures a low cost connection with reliability equal to gold plating.
- The Low Insertion Force (LIF) contacts positioning provides a reliable and easy mating operation.
- Fork shaped contacts mean stable and low contact resistance.
- Kinked solder tails provide added PCB retention.

Technical Data

PC Board pattern (component side)

Material

Housing: PBT, glass reinforced, UL94V-0, Black
Contact: Phosphor Bronze, Tin alloy plated



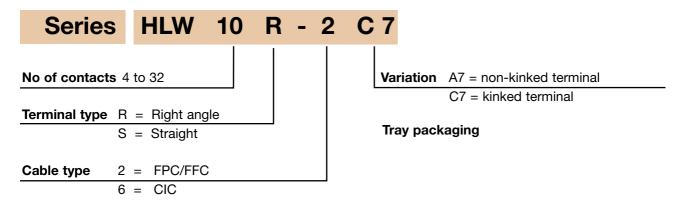
THICKNESS: 1.2~1.6

HLW series - LIF / Through hole

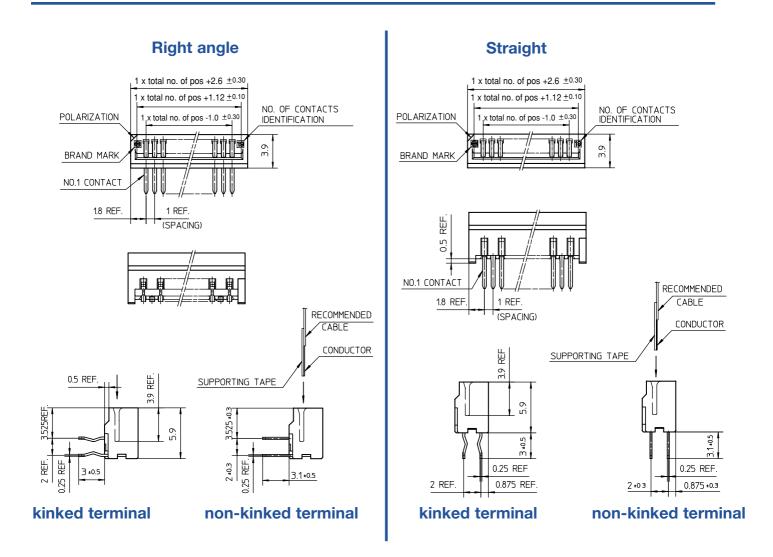


1.00 mm Spacing for FFC / FPC / CIC

Ordering Data



Dimensions



Circuitry Type For Recommended Circuitry type see page 31